1-2199298-2 <

DIPLOMATE TE Internal #: 1-2199298-2 Stamped & Formed, 8 Position, Low Profile, Through Hole, Tin (Sn), -40 – 105 °C [-40 – 221 °F], DIP Sockets

View on TE.com >





Contact Fabrication: Stamped & Formed

Number of Positions: 8

Connector Profile: Low

Row-to-Row Spacing: 7.62 mm [.3 in]

Leg Style: Through Hole

All DIP Socket: Low Profile, Stamped & Formed, Open, Tin (6)

Features

Product Type Features

Connector & Contact Terminates To

Lea Style

Printed Circuit Board

Through Hole



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Configuration Features

PCB Mount Orientation	Vertical			
Number of Rows	2			
Number of Positions	8			
Electrical Characteristics				
Contact Resistance	20 mΩ			
Insulation Resistance	1000 MΩ			
Body Features				
Sleeve Plating Material	Tin/Lead			
Frame Style	Ladder			
Sleeve Material	Brass/Copper			
Connector Profile	Low			
Contact Features				
Mating Contact Type	Dual Leaf			

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Contact Base Material	Phosphor Bronze
IC Socket Type	DIP
PCB Contact Termination Area Plating Material	Tin
Contact Type	Pin
Contact Fabrication	Stamped & Formed
Contact Mating Area Plating Material	Tin (Sn)
	60 µin
Contact Current Rating (Max)	1 A
Termination Features	
Termination Method to PCB	Through Hole - Solder
	3 in
Mechanical Attachment	
Connector Mounting Type	Board Mount
Mating Alignment Type	Polarization
Mating Alignment	With
Housing Features	
Housing Color	Black
Housing Material	PBT GF30
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Product Length	10.16 mm[.4 in]
Profile Height from PCB	5.1 mm[.2 in]
Row-to-Row Spacing	7.62 mm[.3 in]
Usage Conditions	
Operating Temperature Range	-40 – 105 °C[-40 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Tubes per Box	2
Packaging Method	Box & Tube

C For support call+1 800 522 6752

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Packaging Quantity	60			
Other				
Quantity per Tube	6000			
Product Compliance For compliance documentation, visit the product page on TE.com>				
EU RoHS Directive 2011/65/EU	Compliant			
EU ELV Directive 2000/53/EC	Out of Scope			
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold			
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC			
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.			
Solder Process Capability	Wave solder capable to 240°C			

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge

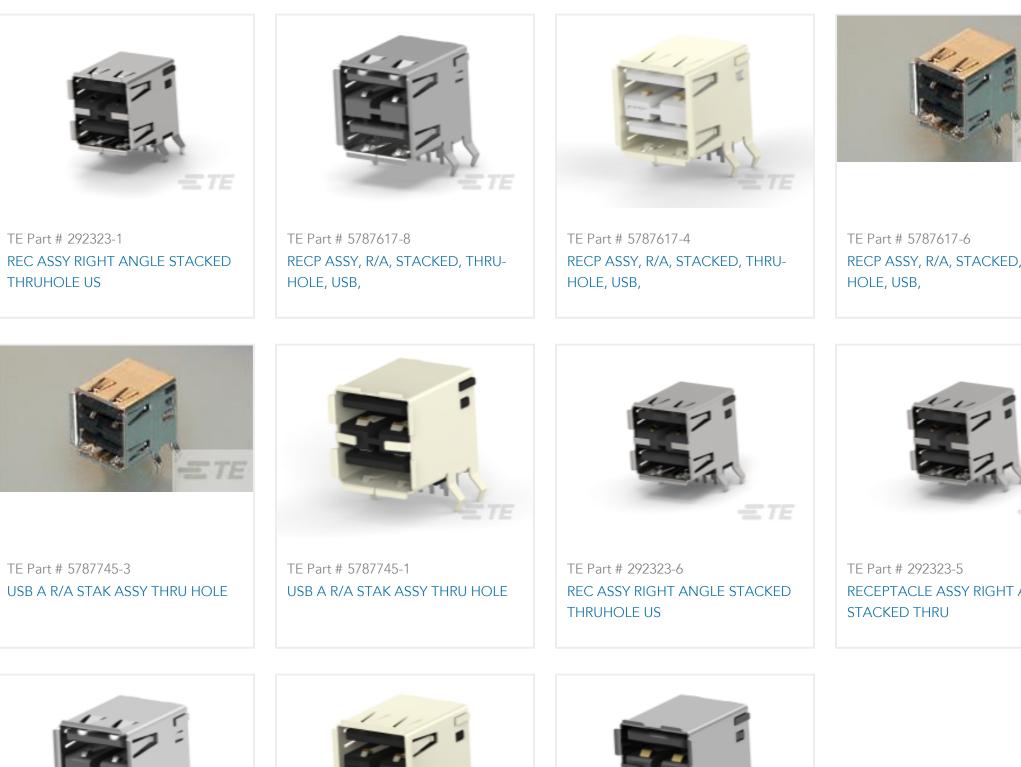
based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



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RECP ASSY, R/A, STACKED, THRU-



TE Part # 5787617-1 RECP ASSY, R/A, STACKED, THRU-HOLE, USB,



TE Part # 5787745-5 USB A R/A STAK ASSY THRU HOLE



RECEPTACLE ASSY RIGHT ANGLE

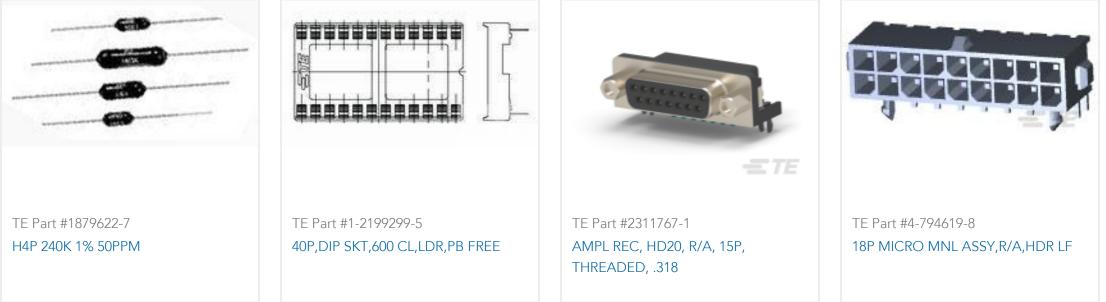
Customers Also Bought

TE Part # 5787617-5

HOLE, USB,

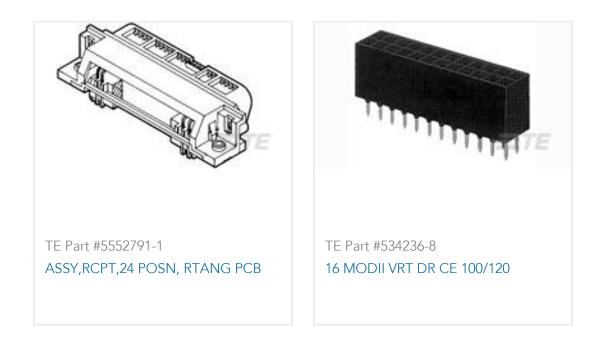
RECP ASSY, R/A, STACKED, THRU-





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Documents

Product Drawings 8P,DIP SKT,300 CL,LDR,PB FREE

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-2199298-2_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-2199298-2_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-2199298-2_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages DIP Sockets Quick Reference Guide (EN)

English